

## **N-Channel MOSFET**

## **Description**

The PNMTAF600V20 is a high voltage MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

MOSFET Product Summary			
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	
600	0.31 @ V <sub>GS</sub> = 10V	20	



TO-247 (Top View)

## **Feature**

- Fast switching capability
- > Avalanche energy tested
- Improved dv/dt capability, high ruggedness

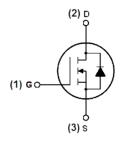
## **Mechanical Characteristics**

> Case: TO-247-3L

➤ Approx. Weight: 6.3g (0.22oz)

> Lead free finish, RoHS compliant

> Case Material: "Green" molding compound, UL flammability classification 94V-0, "Halogen-free".



Schematic diagram

## Absolute maximum rating@25°C

Rating		Symbol	Value	Units	
Drain-Source Voltage		V <sub>DSS</sub>	600	V	
Gate-Source Voltage		V <sub>GSS</sub>	±30	V	
Davis Comment Combination	Tc=25°C	,	20	^	
Drain Current-Continuous	Tc=100°C	I <sub>D</sub>	14.4	A	
Pulsed Drain Current <sup>2)</sup>		I <sub>DM</sub>	80	A	
Avalanche Energy Single Pulsed <sup>3)</sup>		E <sub>AS</sub>	1200	mJ	
Peak Diode Recovery dv/dt <sup>4)</sup>		dv/dt	50	V/ns	
Maximum Power Dissipation		P <sub>D</sub>	219	W	
Thermal Resistance , Junction-case		$R_{ heta JC}$	0.57	°C/W	
Thermal Resistance Junction-to-Ambient		$R_{\theta JA}$	62.5	°C/W	
Junction and Storage Temperature Range		$T_{J_{i}}T_{STG}$	-55~+150	°C	

<sup>1.</sup> Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is

<sup>2.</sup> Repetitive Rating: Pulse width limited by maximum junction temperature. 3. L = 10mH,  $I_{AS}$  = 16.2A,  $V_{DD}$  = 50V,  $R_{G}$  = 25  $\Omega$ , Starting  $T_{J}$  = 25°C 4.  $I_{SD}$  ≤ 20A, di/dt ≤ 200A/µs,  $V_{DD}$  ≤ BV<sub>DSS</sub>, Starting  $T_{J}$  = 25°C

# Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	$V_{GS} = 0V, I_{D} = 250 \mu A$	600	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 600V,V <sub>GS</sub> = 0V	-	-	1.0	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{V}, V_{DS} = 0 \text{V}$	-	-	±100	nA
On Characteristics	On Characteristics					
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0	3.3	4.0	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10V,I <sub>D</sub> = 10A	-	0.31	0.43	Ω
Dynamic Characteristics						
Input Capacitance	C <sub>lss</sub>		-	2762	-	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz	-	266	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	7.5	-	
Switching Characteristics						
Total Gate Charge <sup>1)</sup>	$Q_g$		-	52	-	nC
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 400V, V_{GS} = 10V$ $I_{D} = 20A, I_{G} = 1mA^{1/2}$	-	12.6	-	
Gate-Drain Charge	$Q_{gd}$		-	18.6	-	
Turn-on Delay Time <sup>1)</sup>	t <sub>d(on)</sub>		-	34	-	
Turn-on Rise Time	t <sub>r</sub>	V <sub>DS</sub> = 250V. V <sub>CS</sub> = 10V.	-	65	-	
Turn-Off Delay Time	$t_{d(off)}$	$V_{DS} = 250V, V_{GS} = 10V,$ $I_{D} = 20A, R_{G} = 25\Omega^{1)(2)}$	-	82	-	ns
Turn-Off Fall Time	t <sub>f</sub>		-	45	-	
Drain-Source Diode Characteristics						
Diode Forward Current	I <sub>SD</sub>		-	-	20	Α
Pulsed Drain-Source Current	I <sub>SM</sub>		-	-	80	Α
Diode Forward Voltage <sup>1)</sup>	V <sub>SD</sub>	$V_{GS} = 0V, I_{S} = 20A$	-	-	1.4	V
Reverse Recovery Time <sup>1)</sup>	t <sub>rr</sub>	$V_{GS} = 0V, I_{S} = 20A,$	-	470	-	nS
Reverse Recovery Charge	Q <sub>rr</sub>	di/dt = 100A/μs	-	5.0	-	μC

Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.
 Essentially independent of operating temperature.

# Typical Characteristics

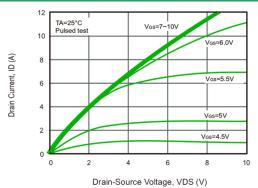


Fig.1 Drain Current vs. Gate-Source Voltage

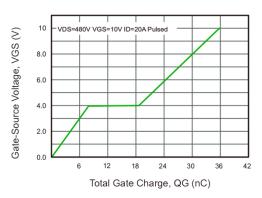


Fig.3 Gate Charge Characteristics

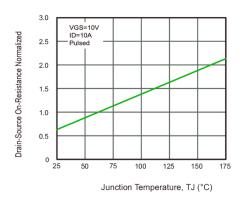


Fig.5 Drain-Source On-Resistance vs. Junction Temperature

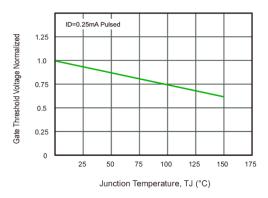


Fig.7 Gate Threshold Voltage vs. Junction Temperature

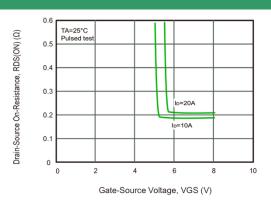


Fig.2 Drain-Source On-Resistance vs. Gate-Source Voltage

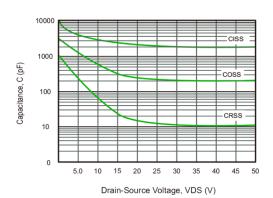


Fig.4 Capacitance Characteristics

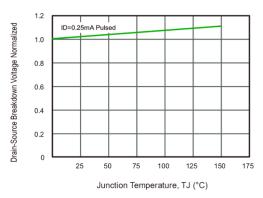


Fig.6 Breakdown Voltage vs. Junction Temperature

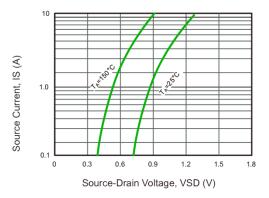


Fig.8 Source Current vs. Source-Drain Voltage

# PNMTAF600V20

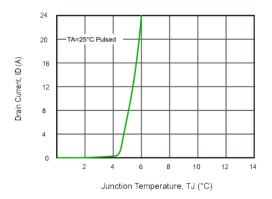


Fig.9 Drain Current vs. Gate-Source Voltage

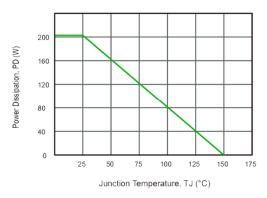


Fig.11 Power Dissipation vs. Junction Temperature

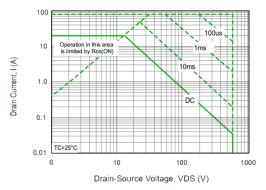


Fig.13 Safe Operating Area

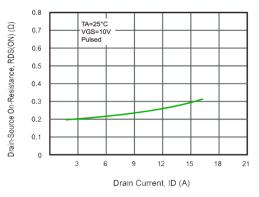


Fig.10 Drain-Source On-Resistance vs. Drain Current

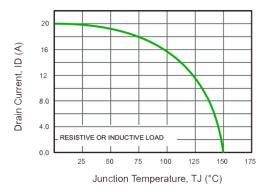
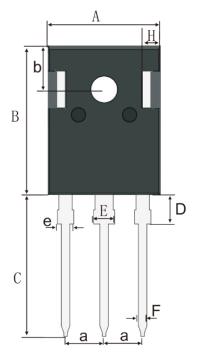
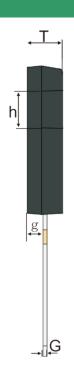


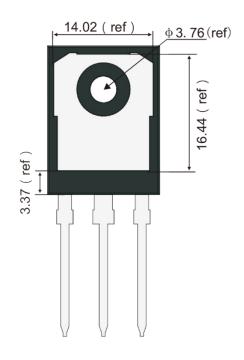
Fig.12 Drain Current vs. Junction Temperature

# **N-Channel MOSFET**

# Product dimension (TO-247-3L)







Dim	Millim	neters	Inches		
Dim	Min	Max	Min	Max	
А	15.61	16.01	0.615	0.630	
В	20.78	21.78	0.818	0.857	
b	6.06	6.26	0.239	0.246	
С	19.8	20.2	0.780	0.795	
D	4.05	4.25	0.159	0.167	
E	2.85	3.15	0.112	0.124	
е	1.90	2.20	0.075	0.087	
F	1.10	1.30	0.043	0.051	
g	2.29	2.49	0.090	0.098	
G	0.50	0.70	0.020	0.028	
Т	4.80	5.20	0.189	0.205	
t	1.81	2.21	0.071	0.087	
а	5.34	5.54	0.210	0.218	
Н	2.31	2.71	0.091	0.107	
h	4.97	5.37	0.196	0.211	

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